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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET

MOS FIELD EFFECT TRANSISTOR μ PA2727UT1A

SWITCHING N-CHANNEL POWER MOSFET

DESCRIPTION

The μ PA2727UT1A is N-channel MOSFET designed for DC/DC converter applications.

FEATURES

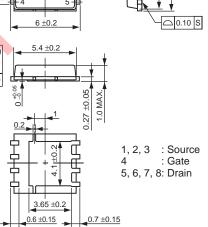
- Low on-state resistance $R_{DS(on)1} = 9.6 \text{ m}\Omega \text{ MAX.}$ (VGS = 10 V, ID = 8 A) $R_{DS(on)2} = 15 \text{ m}\Omega \text{ MAX.}$ (VGS = 4.5 V, ID = 8 A)
- Low QGD
- QGD = 3.5 nC TYP. (VDD = 15 V, ID = 16 A)
- Thin type surface mount package with heat spreader (8-pin HVSON)
- RoHS Compliant

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, All terminals are connected.)

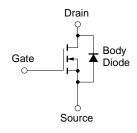
Drain to Source Voltage (V _{GS} = 0 V)	VDSS	30	V
Gate to Source Voltage (VDs = 0 V)	Vgss	±20	V
Drain Current (DC)	ID(DC)	±16	А
Drain Current (pulse) Note1	ID(pulse)	±96	А
Total Power Dissipation Note2	PT1	1.5	W
Total Power Dissipation (PW = 10 sec) ^{Note2}	PT2	4.6	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note3	las	16	А
Single Avalanche Energy Note3	Eas	26	mJ
THERMAL RESISTANCE			
Channel to Ambient Thermal Resistance Note2	Rth(ch-A)	83.3	°C/W
Channel to Case (Drain) Thermal Resistance	Rth(ch-C)	2.0	°C/W



PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT



Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

- 2. Mounted on a glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mm
- **3.** Starting T_{ch} = 25°C, V_{DD} = 15 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V, L = 100 μ H
- **Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

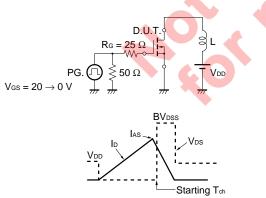
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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	loss	V _{DS} = 30 V, V _{GS} = 0 V			10	μA
Gate Leakage Current	Igss	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5		2.5	V
Forward Transfer Admittance Note	y _{fs}	V _{DS} = 10 V, I _D = 8 A	6			S
Drain to Source On-state Resistance Note	RDS(on)1	V _{GS} = 10 V, I _D = 8 A		7.6	9.6	mΩ
	RDS(on)2	V _{GS} = 4.5 V, I _D = 8 A		11	15	mΩ
Input Capacitance	Ciss	V _{DS} = 15 V,		1170		pF
Output Capacitance	Coss	V _{GS} = 0 V,		250		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		90		pF
Turn-on Delay Time	td(on)	VDD = 15 V, ID = 8 A,		13		ns
Rise Time	tr	V _{GS} = 10 V,		3.6		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		41		ns
Fall Time	tr			8		ns
Total Gate Charge	QG	V _{DD} = 15 V,		11		nC
Gate to Source Charge	QGS	V _{GS} = 5 V,		3.8		nC
Gate to Drain Charge	Qgd	ID = 16 A		3.5		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 16 A, VGS = 0 V		0.83		V
Reverse Recovery Time	trr	I⊧ = 16 A, V _{GS} = 0 V,		27		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		23		nC
Gate Resistance	Rg	f = 1 MHz		2.2		Ω

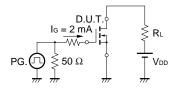
ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

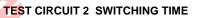
Note Pulsed

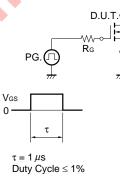
TEST CIRCUIT 1 AVALANCHE CAPABILITY



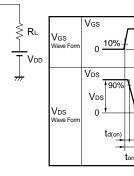
TEST CIRCUIT 3 GATE CHARGE







0.



90%

90%

tſ

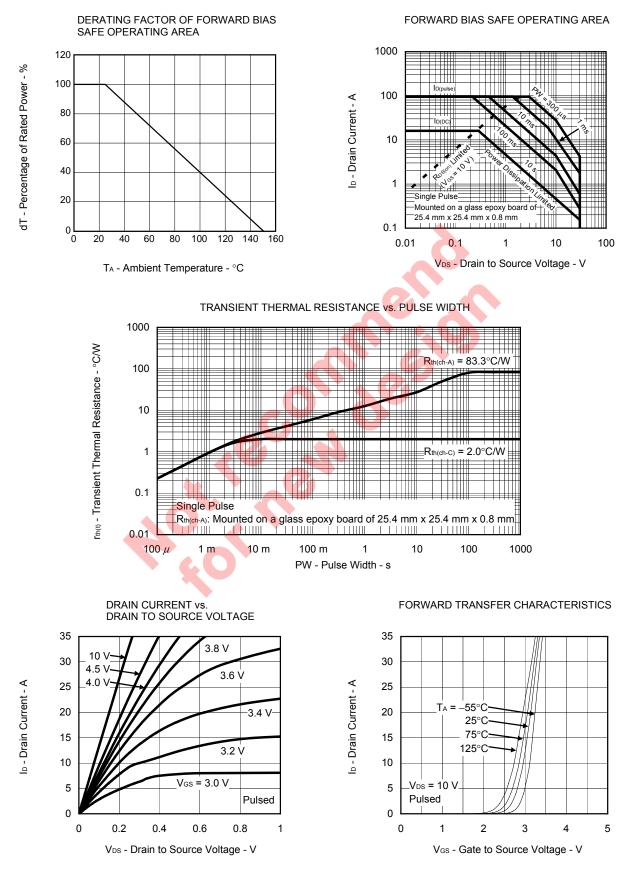
toff

Vgs

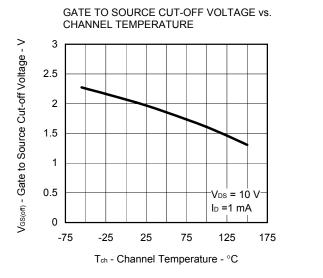
10% 10%

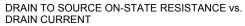
td(off)

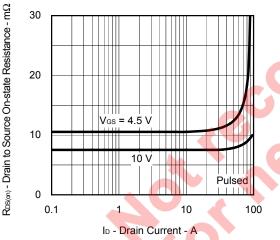
TYPICAL CHARACTERISTICS (T_A = 25°C)

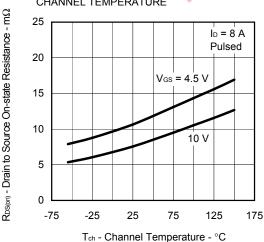










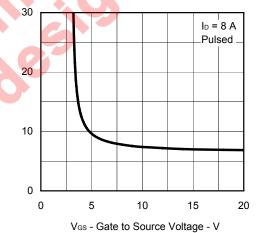


DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE

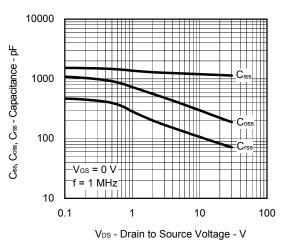
DRAIN CURRENT 100 S | yts | - Forward Transfer Admittance -T₄ = –55°C 25°C 75°C 10 125°C 1 V_{DS} = 10 V Pulsed 0.1 0.1 1 10 100 ID - Drain Current - A

FORWARD TRANSFER ADMITTANCE vs.

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



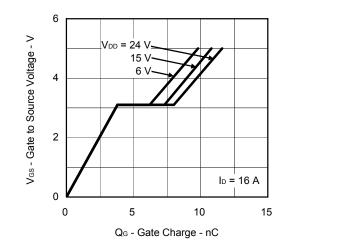
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

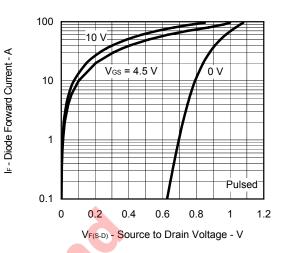


RDS(on) - Drain to Source On-state Resistance - m0

DYNAMIC INPUT/OUTPUT CHARACTERISTICS

SOURCE TO DRAIN DIODE FORWARD VOLTAGE





ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE	
μΡΑ2727UT1Α-E1-AZ ^{Note}	Ca Di			
μ PA2727UT1A-E2-AZ ^{Note}	Sn-Bi		8-pin HVSON	
μ PA2727UT1A-E1-AY ^{Note}	D 0.	Tape 3000 p/reel	0.10 g TYP.	
μ PA2727UT1A-E2-AY ^{Note}	Pure Sn			

Note Pb-free (This product does not contain Pb in the external electrode.)

Not r

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